

REPLY UNDER 37 CFR §1.116
EXPEDITED PROCEDURE
TECHNOLOGY CENTER 2800

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:	§	Attorney Docket No.
Hsien-Wei Chen, et al.	§	2003-1410 / 24061.193
	§	
Serial No.: 10/801,475	§	Customer No. 42717
	§	
Filed: March 16, 2004	§	Group Art Unit: 2822
	§	
For: SYSTEM FOR HEAT	§	Examiner: Monica Lewis
DISSIPATION IN	§	
SEMICONDUCTOR DEVICES	§	Confirmation No.: 1783

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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

I hereby certify that this correspondence (including any listed enclosures) is being electronically filed in the United States Patent and Trademark Office via the EFS-Web system on November 21, 2007.


Linda Ingram

AMENDMENT UNDER 37 C.F.R. §1.116
IN RESPONSE TO ADVISORY ACTION

This Amendment is submitted in reply to the Advisory Action mailed on October 30, 2007, as well as the "final" Office Action mailed on September 14, 2007. Applicants have previously paid filing fees in an amount sufficient to cover all of the claims that will be pending after entry of the claim amendments below, and thus no additional filing fee is due in association with the submission of this Amendment.